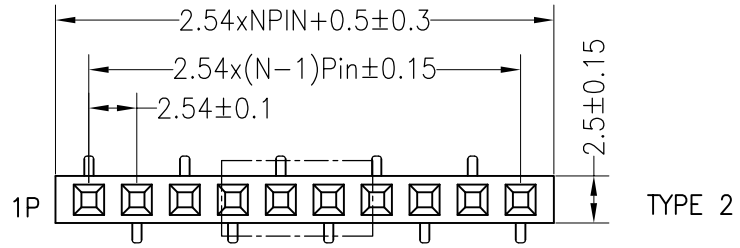
HSF RoHS

FILE NO :E362810

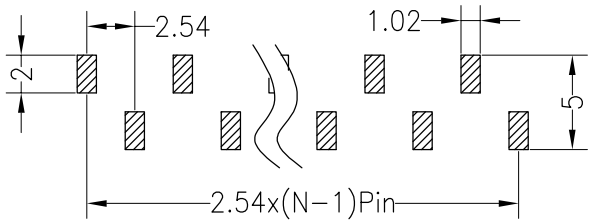
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

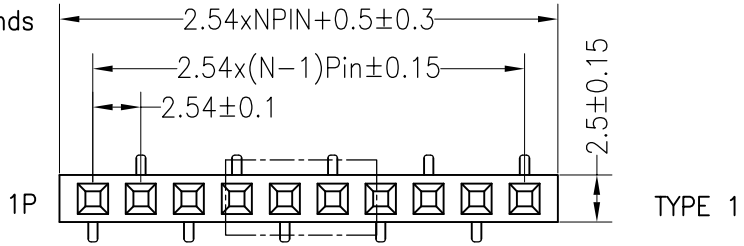


TYPE 2

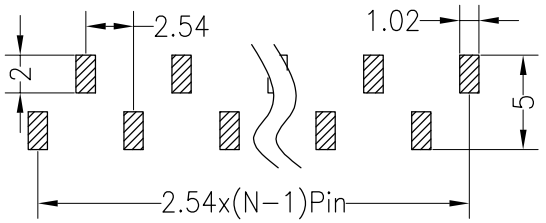
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE 2



TYPE 1

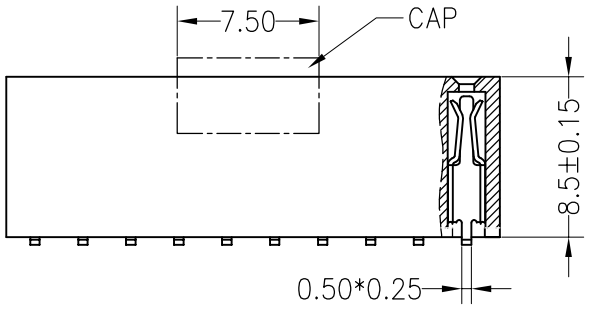


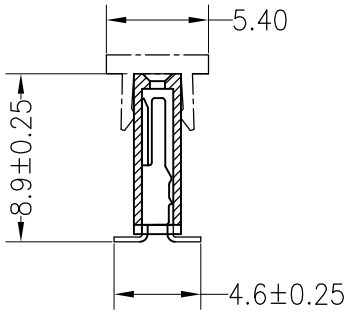
TYPE 1

Ordering Information

2285 01 XX X N XX M U X 01(2)

No.of Pins Per Row 1*2~1*40	Insulator Material Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 E=BK−PA9T F=BK−LCP	Post W=With Post N=W/O Post	Contact Plating G0:Gold Flash G1:3U" Gold G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin	Packing T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar			





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2020.04.18	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	20.04.18
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	228501XXXNXXMUX01(2)
TITLE:	2.54PF H8.5mm 1xNpin SMT U−Type